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TRANSISTORS, LOW POWER, NPN, BASED ON TYPE 2N2222A

ESCC Detail Specification No. 5201/002

ISSUE 1 October 2002





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TRANSISTORS, LOW POWER, NPN, BASED ON TYPE 2N2222A

ESA/SCC Detail Specification No. 5201/002



space components coordination group

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1. GENERAL

1.1 SCOPE

This specification details the ratings, physical and electrical characteristics, test and inspection data for Transistors, Low Power, NPN, based on Type 2N2222A. It shall be read in conjunction with ESA/SCC Generic Specification No. 5000, the requirements of which are supplemented herein.

1.2 <u>COMPONENT TYPE VARIANTS</u>

Variants of the basic transistors specified herein, which are also covered by this specification, are given in Table 1(a).

1.3 MAXIMUM RATINGS

The maximum ratings, which shall not be exceeded at any time during use or storage, applicable to the transistors specified herein, are scheduled in Table 1(b).

1.4 PARAMETER DERATING INFORMATION

The derating information applicable to the transistors specified herein is shown in Figure 1.

1.5 PHYSICAL DIMENSIONS

The physical dimensions of the transistors specified herein are shown in Figure 2.

1.6 FUNCTIONAL DIAGRAM

The functional diagram, showing lead identification, of the transistors specified herein, is shown in Figure 3.

1.7 <u>HIGH TEMPERATURE TEST PRECAUTIONS</u>

For tin-lead plated or solder-dipped lead finish, all tests to be performed at a temperature that exceeds +125°C shall be carried out in 100% inert atmosphere.

2. APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:-

- (a) ESA/SCC Generic Specification No. 5000 for Discrete Semiconductors.
- (b) MIL-STD-750, Test Methods and Procedures for Semiconductor Devices.

3. TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESA/SCC Basic Specification No. 21300 shall apply.

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TABLE 1(a) - TYPE VARIANTS

VARIANT	BASED ON TYPE	CASE	FIGURE	LEAD MATERIAL AND/OR FINISH
01	2N2222A	TO18	2(a)	D2
02	2N2222A	TO18	2(a)	D3 or D4
03	2N2222A	TO18	2(a)	D7
04	2N2222A	CHIP CARRIER	2(b)	2
05	2N2222A	CHIP CARRIER	2(b)	4
06	2N2222A	TO18	2(a)	D2
07	2N2222A	TO18	2(a)	D3 or D4
08	2N2222A	TO18	2(a)	D7
09	2N2222A	CHIP CARRIER	2(b)	2
10	2N2222A	CHIP CARRIER	2(b)	4

TABLE 1(b) - MAXIMUM RATINGS

No.	CHARACTERISTICS	SYMBOL	MAXIMUM RATING	UNIT	REMARKS
1	Collector-Base Voltage	V _{CBO}	75	V	Over entire operating
2	Collector-Emitter Voltage Variants 01 to 05 Variants 06 to 10	V _{CEO}	40 50	V	temperature range
3	Emitter-Base Voltage	V _{EBO}	6.0	V	
4	Collector Current	lc	800	mA	10µs pulse
5	Power Dissipation 1 All Variants Variants 04-05-09-10	P _{tot1}	0.5 0.73 (1)	W	At T _{amb} ≤ +25°C Note 2
6	Power Dissipation 2 Variants 01-02-03-06-07-08	P _{tot2}	1.8	W	At T _{case} ≤ +25°C Note 2
7	Operating Temperature Range	T _{op}	-65 to +200	°C	T _{amb}
8	Storage Temperature Range	T _{stg}	-65 to +200	°C	·
9	Soldering Temperature Variants 01-02-03-06-07-08 Variants 04-05-09-10	T _{sol}	+ 260 + 245	°C	Note 3 Note 4

NOTES

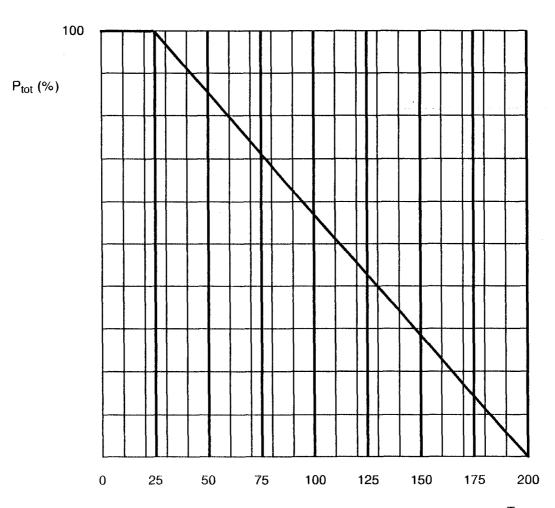
- 1. When mounted on a 15×15×0.6mm ceramic substrate.
- 2. For derating at T_{amb} or $T_{case} > +25$ °C, see Figure 1.
- 3. Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the same lead shall not be resoldered until 3 minutes have elapsed.
- 4. Duration 5 seconds maximum and the same terminal shall not be resoldered until 3 minutes have elapsed.



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FIGURE 1 - PARAMETER DERATING INFORMATION



T_{amb} or T_{case} (°C)

Power Dissipation versus Temperature



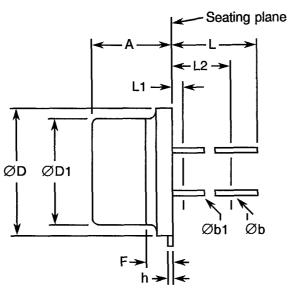
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FIGURE 2 - PHYSICAL DIMENSIONS

FIGURE 2(a) - VARIANTS 01-02-03-06-07-08





2. Base.

3. Collector (Note 7).

Øa

h > <			→	
SYMBOL	MILLIMI	MILLIMETRES		
STIMBUL	MIN.	MAX	NOTES	
Α	4.32	5.33		
Øa	2.54	T.P.	4	
Øb	0.41	0.53	5, 6	
Øb1	0.41	0.48	5, 6	
ØD	5.31	5.84		
ØD1	4.52	4.95		
F	-	0.76	3	
h	0.23	1.04		
j	0.91	1.17	1	
k	0.71	1.22	1, 2	
L	12.70	19.05	5, 6	
L1	-	1.27	5, 6	
L2	6.35	-	5, 6	
r	-	0.25	8	
a	45°	Т.Р.	4	

NOTES

- 1. Beyond r (radius) maximum, j shall be held for a minimum length of 0.28mm.
- 2. k measured from maximum \emptyset D.
- 3. Body contour optional within zone defined by ØD, ØD1 and F.
- 4. Leads at gauge plane 1.37 + 0.03 0.00 mm below the seating plane shall be within 0.18mm radius of True Position (T.P.) at maximum material condition (MMC) relative to tab at MMC. The device may be measured by direct methods or by gauging procedure.
- 5. Øb1 applies between L1 and L2. Øb applies between L2 and L minimum. Diameter is uncontrolled in L1 and beyond L minimum.
- 6. All three leads.
- 7. The collector shall be internally connected to the case.
- 8. r (radius) applies to both inside corners of tab.



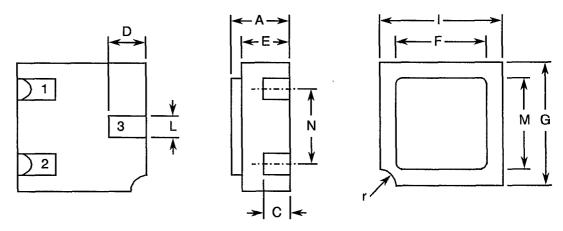
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FIGURE 2 - PHYSICAL DIMENSIONS (CONTINUED)

FIGURE 2(b) - VARIANTS 04-05-09-10

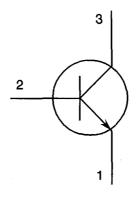


SYMBOL	MILLIMI	ETRES	NOTES	
STIVIDOL	MIN.	MAX	NOTES	
Α	1.15	1.50	· · · · · · · · · · · · · · · · · · ·	
С	0.45	0.56	1	
D	0.60	0.91	1	
E	0.91	1.12		
F	1.90	2.15		
G	2.90	3.25		
1	2.40	2.85		
L	0.40	0.60	1	
М	2.40	2.65		
N	1.80	2.00		
r	0.3	ΓΥΡ.		

NOTES

1. The three pads have the same dimensions.

FIGURE 3 - FUNCTIONAL DIAGRAM



- 1. Emitter.
- 2. Base.
- 3. Collector.

NOTES

1. For Variants 01 to 03, the collector is internally connected to the case.



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4. **REQUIREMENTS**

4.1 GENERAL

The complete requirements for procurement of the transistors specified herein shall be as stated in this specification and ESA/SCC Generic Specification No. 5000 for Discrete Semiconductors. Deviations from the Generic Specification, applicable to this specification only, are listed in Para. 4.2.

Deviations from the applicable Generic Specification and this Detail Specification, formally agreed with specific Manufacturers on the basis that the alternative requirements are equivalent to the ESA/SCC requirements and do not affect the components' reliability, are listed in the appendices attached to this specification.

4.2 DEVIATIONS FROM GENERIC SPECIFICATION

4.2.1 Deviations from Special In-process Controls

None.

4.2.2 <u>Deviations from Final Production Tests (Chart II)</u>

None.

4.2.3 Deviations from Burn-in and Electrical Measurements (Chart III)

(a) Para. 7.1.1(a), High Temperature Reverse Bias test and subsequent electrical measurements related to this test shall be omitted.

4.2.4 Deviations from Qualification Tests (Chart IV)

None.

4.2.5 Deviations from Lot Acceptance Tests (Chart V)

None.

4.2.5 Deviations from Lot Acceptance Tests (Chart V)

None.

4.3 MECHANICAL REQUIREMENTS

4.3.1 <u>Dimension Check</u>

The dimensions of the transistors specified herein shall be checked. They shall conform to those shown in Figure 2.

4.3.2 Weight

The maximum weight of the transistors specified herein shall be 0.4 grammes for Variants 01-02-03-06-07-08 and 0.06 grammes for Variants 04-05-09-10.



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4.3.3 Terminal Strength

The requirements for terminal strength testing are specified in Section 9 of ESA/SCC Generic Specification No. 5000. For Variants 01 to 03 and 06-08, the test conditions shall be as follows:-

Test Condition:

'E', Lead Fatigue.

4.4 MATERIALS AND FINISHES

The materials and finishes shall be as specified herein. Where a definite material is not specified, a material which will enable the transistors specified herein to meet the performance requirements of this specification shall be used. Acceptance or approval of any constituent material does not quarantee acceptance of the finished product.

4.4.1 Case

For Variants 01 to 03 and 06-08, the case shall be hermetically sealed and have a metal body with hard glass seals and the lid shall be welded, brazed, preform soldered or glass frit sealed.

For Variants 04 and 05 and 09-10, the case shall be hermetically sealed and have a ceramic body with a kovar lid.

4.4.2 Lead Material and Finish

For Variants 01 to 03 and 06-08, the lead material shall be Type 'D' with either Type '2', Type '3 or 4' or Type '7' finish in accordance with the requirements of ESA/SCC Basic Specification No. 23500. (See Table 1(a) for Type Variants).

For Variants 04 and 05 and 09-10, the terminal finish shall be either Type '2' or Type '4' in accordance with the requirements of ESA/SCC Basic Specification No. 23500. (See Table 1(a) for Type Variants).

4.5 MARKING

4.5.1 General

The marking of all components delivered to this specification shall be in accordance with the requirements of ESA/SCC Basic Specification No. 21700 and the following paragraphs. When the component is too small to accommodate all of the marking specified, as much as space permits shall be marked and the marking information, in full, shall accompany the component in its primary package.

The information to be marked and the order of precedence, shall be as follows:-

- (a) Lead Identification.
- (b) The SCC Component Number.
- (c) Traceability Information.

4.5.2 <u>Lead Identification</u>

Lead identification shall be as shown in Figures 2 and 3.



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4.5.3 The SCC Component Number

Each component shall bear the SCC Component Number which shall be constituted and marked as follows:

	<u>520100202B</u>
Detail Specification Number ———	
Type Variant (see Table 1(a))	
Testing Level (B or C, as applicable)	

4.5.4 <u>Traceability Information</u>

Each component shall be marked in respect of traceability information in accordance with the requirements of ESA/SCC Basic Specification No. 21700.

4.6 <u>ELECTRICAL MEASUREMENTS</u>

4.6.1 Electrical Measurements at Room Temperature

The parameters to be measured at room temperature are scheduled in Table 2. Unless otherwise specified, the measurements shall be performed at T_{amb} = +22 ±3 °C.

4.6.2 Electrical Measurements at High and Low Temperatures

The parameters to be measured at high and low temperatures are scheduled in Table 3.

4.6.3 Circuits for Electrical Measurements

Circuits for use in performing the electrical measurements listed in Tables 2 and 3 of this specification are shown in Figure 4.

4.7 BURN-IN TESTS

4.7.1 Parameter Drift Values

The parameter drift values applicable to burn-in are specified in Table 4 of this specification. Unless otherwise stated, the measurements shall be performed at T_{amb} = +22±3 °C. The parameter drift values (Δ) applicable to the parameters scheduled, shall not be exceeded. In addition to these drift value requirements, the appropriate limit value specified for a given parameter in Table 2 shall not be exceeded.

4.7.2 Conditions for High Temperature Reverse Bias Burn-in (Table 5(a))

Not applicable.

4.7.3 Conditions for Power Burn-in

The requirements for power burn-in are specified in Section 7 of ESA/SCC Generic Specification No. 5000. The conditions for power burn-in shall be as specified in Table 5(b) of this specification.

4.7.4 Electrical Circuits for High Temperature Reverse Bias Burn-in (Figure 5(a))

Not applicable.

4.7.5 Electrical Circuits for Power Burn-in

Circuits for use in performing the power burn-in tests are shown in Figure 5(b) of this specification.

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TABLE 2 - ELECTRICAL MEASUREMENTS AT ROOM TEMPERATURE - d.c. PARAMETERS

No	CHARACTERISTICS	COMBACILDICIN'S I SOMBOIL	MIL-STD-750) TEST CONDITIONS	LIMITS		UNIT
No.	CHARACTERISTICS	STRIBUL	TEST METHOD	TEST CONDITIONS	MIN.	MAX.	UNII
1	Collector-Base Breakdown Voltage	V _{(BR)CBO}	3001	I _C = 100µA	75	-	V
2	Collector-Emitter Breakdown Voltage Variants 01-05 Variants 06-10	V _{(BR)CEO}	3011	I _C = 30mA I _C = 10mA	40 50	-	V
3	Emitter-Base Breakdown Voltage	V _{(BR)EBO}	3026	l _E = 100μA	6.0	-	V
4	Collector-Base Cut-off Current	Ісво	3036	V _{CB} = 60V	-	10	nA
5	Emitter-Base Cut-off Current	I _{EBO}	3061	V _{EB} = 3.0V	-	10	nA
6	Collector-Emitter Saturation Voltage	V _{CE(SAT)}	3071	I _C = 150mA, I _B = 15mA Note 1	-	0.3	V
7	Base-Emitter Saturation Voltage	V _{BE(SAT)}	3066	I _C = 150mA, I _B = 15mA Note 1	-	1.2	V
8	D.C. Forward Current Transfer Ratio 1	h _{FE1}	3076	l _C = 100μA V _{CE} = 10V	35	-	-
9	D.C. Forward Current Transfer Ratio 2	h _{FE2}	3076	I _C = 10mA V _{CE} = 10V	75	•	-
10	D.C. Forward Current Transfer Ratio 3	h _{FE3}	3076	I _C = 150mA V _{CE} = 10V Note 1	100	300	-
11	D.C. Forward Current Transfer Ratio 4	h _{FE4}	3076	I _C = 500mA V _{CE} = 10V Note 1	40	-	-

NOTES: See Note 14.



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TABLE 2 - ELECTRICAL MEASUREMENTS AT ROOM TEMPERATURE - a.c. PARAMETERS

No.	CHARACTERISTICS	SYMBOL	BOL MIL-STD-750 TEST CONDITIONS (NOTE 2) MIN.	ITS	UNIT		
	OHAINOTENISTIOS	STIMBOL		(NOTE 2)	MIN.	MAX.	ONIT
12	A.C. Forward Current Transfer Ratio Variants 01 to 05 Variants 06 to 10	h _{fe}	3206	I _C = 20mA V _{CE} = 20V f = 100MHz	3.0 2.5	10 -	•
13	Output Capacitance	C _{obo}	3236	$V_{CB} = 10V$ $I_E = 0A$ $100kHz \le f \le 1.0MHz$	•	8.0	pF
14	Turn-on Time	t _{on}	3251 Cond. B and Fig. 4	V _{CC} = 30V I _C = 150mA I _{B1} = 15mA	-	35	ns
15	Turn-off Time	t _{off}	3251 Cond. B and Fig. 4	V _{CC} = 30V I _C = 150mA I _{B1} = I _{B2} = 15mA	-	285	ns

NOTES

- 1. Pulse measurement: Pulse Width ≤300µs, Duty Cycle ≤1.0%.
- 2. Performed on a sample basis, LTPD = 7.

TABLE 3 - ELECTRICAL MEASUREMENTS AT HIGH AND LOW TEMPERATURES

No.	CHARACTERISTICS	SYMBOL	MIL-STD-750 TEST METHOD	TEST CONDITIONS	LIMITS		UNIT
					MIN.	MAX.	CIVIT
4	Collector-Base Cut-off Current	Ісво	3036	T _{amb} = +150°C V _{CB} = 60V	-	10	μA
9	D.C. Forward Current Transfer Ratio 2	h _{FE2}	3076	T _{amb} = -55°C I _C = 10mA V _{CE} = 10V	35	-	-

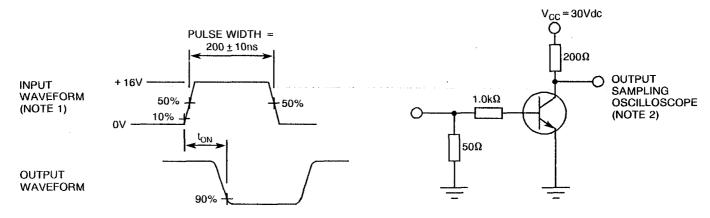


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FIGURE 4 - CIRCUITS FOR ELECTRICAL MEASUREMENTS

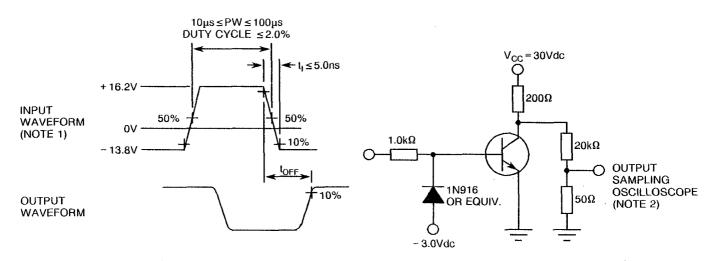
SATURATED TURN-ON SWITCHING TIME TEST CIRCUIT



NOTES

- 1. The rise time (t_r) of the applied pulse shall be ≤ 2.0 ns, duty cycle ≤ 2.0 % and the generator source impedance shall be 50Ω .
- 2. Sampling Oscilloscope: $Z_{in} \ge 100k\Omega$, $C_{in} \le 12pF$, rise time $\le 5.0ns$.

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TABLE 4 - PARAMETER DRIFT VALUES

No.	CHARACTERISTICS	SYMBOL	SPEC. AND/OR TEST METHOD	TEST CONDITIONS	CHANGE LIMIT (Δ)	UNIT
4	Collector-Base Cut-off Current	I _{CBO}	As per Table 2	As per Table 2	±5.0 or (1) ±100	nA %
6	Collector-Emitter Saturation Voltage	V _{CE(SAT)}	As per Table 2	As per Table 2	±30 or (1) ±15	mV %
10	D.C. Forward Current Transfer Ratio 3	h _{FE3}	As per Table 2	As per Table 2	± 15	%

NOTES

1. Whichever is the greater, referred to the initial value.

TABLE 5(a) - CONDITIONS FOR HIGH TEMPERATURE REVERSE BIAS BURN-IN

Not applicable.

TABLE 5(b) - CONDITIONS FOR POWER BURN-IN AND OPERATING LIFE TESTS

No.	CHARACTERISTICS	SYMBOL	CONDITION	UNIT
1	Ambient Temperature	T _{amb}	+20 to +50	°C
2	Power Dissipation 1	P _{tot1}	Max. rating at T _{amb} according to derating curve (Note 1)	W
3	Collector-Base Voltage	V _{CB}	10 to 40	V

NOTES

1. See Item 5 of Table 1(b) and Figure 1.

FIGURE 5(a) - ELECTRICAL CIRCUIT FOR HIGH TEMPERATURE REVERSE BIAS BURN-IN

Not applicable.

FIGURE 5(b) - ELECTRICAL CIRCUIT FOR POWER BURN-IN AND OPERATING LIFE TESTS

Not applicable.



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4.8 <u>ENVIRONMENTAL AND ENDURANCE TESTS (CHARTS IV AND V OF ESA/SCC GENERIC SPECIFICATION No. 5000)</u>

4.8.1 Electrical Measurements on Completion of Environmental Tests

The parameters to be measured on completion of environmental tests are scheduled in Table 2. Unless otherwise stated, the measurements shall be performed at $T_{amb} = +22 \pm 3$ °C.

4.8.2 Electrical Measurements at Intermediate Points and on Completion of Endurance Tests

The parameters to be measured at intermediate points and on completion of endurance testing are scheduled in Table 6 of this specification. Unless otherwise stated, the measurements shall be performed at $T_{amb} = +22 \pm 3$ °C.

4.8.3 Conditions for Operating Life Tests (Part of Endurance Testing)

The requirements for operating life testing are specified in Section 9 of ESA/SCC Generic Specification No. 5000. The conditions for operating life testing shall be the same as specified in Table 5(b) for the power burn-in test.

4.8.4 Electrical Circuits for Operating Life Tests

The circuit to be used for performance of the operating life test shall be the same as shown in Figure 5(b) for power burn-in.

4.8.5 Conditions for High Temperature Storage Test (Part of Endurance Testing)

The requirements for the high temperature storage test are specified in ESA/SCC Generic Specification No. 5000. The temperature to be applied shall be the maximum storage temperature specified in Table 1(b) of this specification.



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TABLE 6 - ELECTRICAL MEASUREMENTS AT INTERMEDIATE POINTS AND ON COMPLETION OF ENDURANCE TESTING

No.	CHARACTERISTICS	SYMBOL	SPEC. AND/OR	TEST	LIM	MITS	UNIT
	CHARACTERISTICS	JIMBOL	TEST METHOD	CONDITIONS	MIN.	MAX.	ONIT
4	Collector-Base Cut-off Current	Ісво	As per Table 2	As per Table 2	-	10	nA
6	Collector-Emitter Saturation Voltage	V _{CE(SAT)}	As per Table 2	As per Table 2	-	0.3	٧
10	D.C. Forward Current Transfer Ratio 3	h _{FE3}	As per Table 2	As per Table 2	100	300	-



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APPENDIX 'A'

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AGREED DEVIATIONS FOR SGS-THOMSON (F)

ITEMS AFFECTED	DESCRIPTION OF DEVIATIONS						
Para. 4.2.2	For Chip Carrier Variants, the visual criteria called up by Para. 9.1, as specified in Paras. 3.2.5(i) and (j) of ESA/SCC Basic Specification No. 2045000, may be omitted provided that a Radiographic Inspection to verify the die-attach process is performed in accordance with Para. 9.12.						
	The Radiographic Inspection shall be performed on a sample basis in accordance with STC Procedure 0011828.						
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